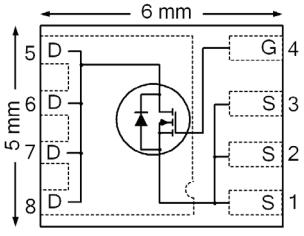
FastIRFET™
IRFH7184PbF

HEXFET® Power MOSFET

V_{DSS}	100	V
$R_{DS(on)}$ max (@ V_{GS} = 10V)	4.8	mΩ
$Q_{g\ (typical)}$	36	nC
$R_{g\ (typical)}$	1.2	Ω
I_D (@$T_{C\ (Bottom)}$ = 25°C)	128	A



PQFN 5X6 mm

Applications

- Optimized for Secondary Side Synchronous Rectification
- Primary Switch for High Frequency 48V/60V Telecom DC-DC Power Supplies
- Hot Swap and Active O-Ring
- BLDC Motor Drive

Features		Benefits
Low $R_{DS(ON)}$ (< 4.8mΩ)		Lower Conduction Losses
Internal Snubber		Reduced Vds Spike, Improved EMI
Low Thermal Resistance to PCB (<0.8°C/W)		Increased Power Density
100% Rg Tested		Increased Reliability
Low Profile (<1.05 mm)	results in ⇒	Increased Power Density
Industry-Standard Pinout		Multi-Vendor Compatibility
Compatible with Existing Surface Mount Techniques		Easier Manufacturing
RoHS Compliant, Halogen-Free		Environmentally Friendlier
MSL1		Increased Reliability

Base part number	Package Type	Standard Pack		Orderable Part Number
		Form	Quantity	
IRFH7184PbF	PQFN 5mm x 6 mm	Tape and Reel	4000	IRFH7184TRPbF

Absolute Maximum Ratings

	Parameter	Max.	Units
V_{GS}	Gate-to-Source Voltage	± 20	V
I_D @ T_A = 25°C	Continuous Drain Current, V_{GS} @ 10V	20	A
I_D @ $T_{C(Bottom)}$ = 25°C	Continuous Drain Current, V_{GS} @ 10V	128	
I_D @ $T_{C(Bottom)}$ = 100°C	Continuous Drain Current, V_{GS} @ 10V	81	
I_{DM}	Pulsed Drain Current ①	260	
P_D @T_A = 25°C	Power Dissipation	3.9	W
P_D @$T_{C(Bottom)}$ = 25°C	Power Dissipation	156	
	Linear Derating Factor	0.03	W/°C
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to + 150	°C

Notes ① through ⑤ are on page 8

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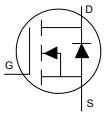
Static @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	100	—	—	V	V_{GS} = 0V, I_D = 250µA
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient	—	54	—	mV/°C	Reference to 25°C, I_D = 1mA
$R_{DS(on)}$	Static Drain-to-Source On-Resistance	—	4.0	4.8	mΩ	V_{GS} = 10V, I_D = 50A ③
$V_{GS(th)}$	Gate Threshold Voltage	2.0	—	3.6	V	V_{DS} = V_{GS}, I_D = 150µA
$\Delta V_{GS(th)}$	Gate Threshold Voltage Coefficient	—	-5.4	—	mV/°C	
I_{DSS}	Drain-to-Source Leakage Current	—	—	1.0	µA	V_{DS} = 80V, V_{GS} = 0V
I_{GSS}	Gate-to-Source Forward Leakage	—	—	100	nA	V_{GS} = 20V
	Gate-to-Source Reverse Leakage	—	—	-100		V_{GS} = -20V
gfs	Forward Transconductance	117	—	—	S	V_{DS} = 25V, I_D = 50A
Q_g	Total Gate Charge	—	36	54	nC	V_{DS} = 50V V_{GS} = 10V I_D = 50A
Q_{gs1}	Pre-Vth Gate-to-Source Charge	—	7.3	—		
Q_{gs2}	Post-Vth Gate-to-Source Charge	—	2.7	—		
Q_{gd}	Gate-to-Drain Charge	—	11	—		
Q_{godr}	Gate Charge Overdrive	—	15	—		
Q_{sw}	Switch Charge (Q_{gs2} + Q_{gd})	—	13.7	—		
Q_{oss}	Output Charge	—	120	—	nC	V_{DS} = 50V, V_{GS} = 0V
R_G	Gate Resistance	—	1.2	2.2	Ω	
$t_{d(on)}$	Turn-On Delay Time	—	6.5	—	ns	V_{DD} = 50V, V_{GS} = 10V I_D = 50A R_G = 1.0Ω
t_r	Rise Time	—	9.9	—		
$t_{d(off)}$	Turn-Off Delay Time	—	14	—		
t_f	Fall Time	—	3.9	—		
C_{iss}	Input Capacitance	—	2320	—	pF	V_{GS} = 0V V_{DS} = 50V f = 1.0MHz
C_{oss}	Output Capacitance	—	1070	—		
C_{rss}	Reverse Transfer Capacitance	—	19	—		

Diode Characteristics

	Parameter	Min.	Typ.	Max.	Units	Conditions
I_S	Continuous Source Current (Body Diode)	—	—	128	A	MOSFET symbol showing the integral reverse p-n junction diode. 
I_{SM}	Pulsed Source Current (Body Diode) ①	—	—	260		
V_{SD}	Diode Forward Voltage	—	0.8	1.3	V	T_J = 25°C, I_S= 50A, V_{GS}=0V ③
t_{rr}	Reverse Recovery Time	—	55	83	ns	T_J = 25°C, I_F = 50A, V_{DD} = 50V
Q_{rr}	Reverse Recovery Charge	—	76	114	nC	di/dt = 100A/µs ③

Avalanche Characteristics

	Parameter	Typ.	Max.	Units
$E_{AS\ (Thermally\ limited)}$	Single Pulse Avalanche Energy ②	—	360	mJ
I_{AR}	Avalanche Current ①	—	50	A

Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$ (Bottom)	Junction-to-Case ④	—	0.8	°C/W
$R_{\theta JC}$ (Top)	Junction-to-Case ④	—	21	
$R_{\theta JA}$	Junction-to-Ambient ⑤	—	32	
$R_{\theta JA}$ (<10s)	Junction-to-Ambient ⑤	—	19	

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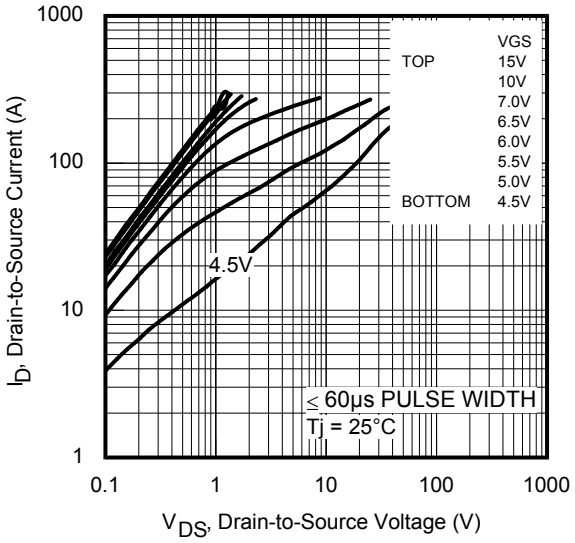

Fig 1. Typical Output Characteristics

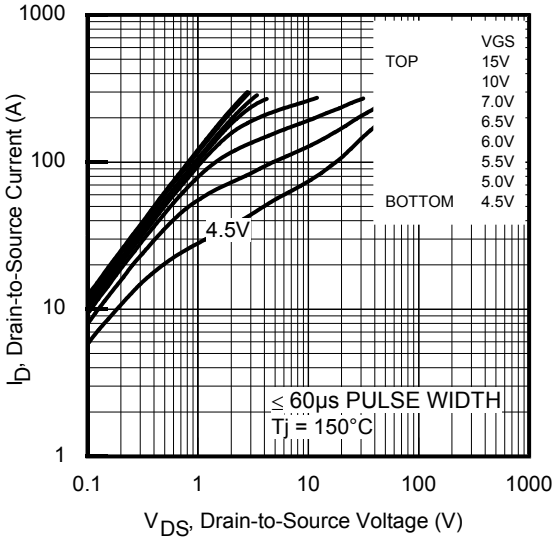

Fig 2. Typical Output Characteristics

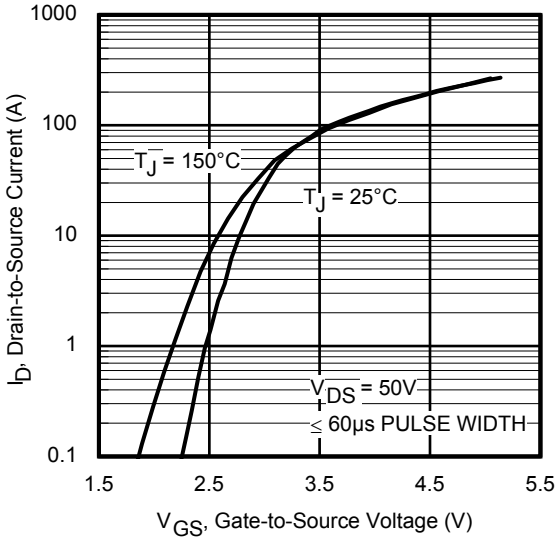

Fig 3. Typical Transfer Characteristics

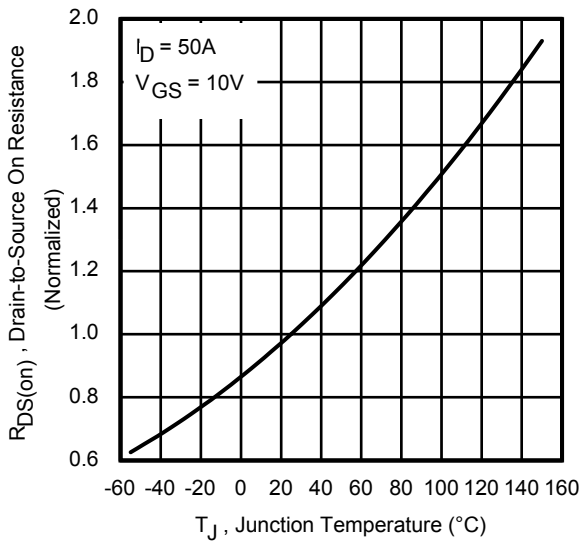

Fig 4. Normalized On-Resistance vs. Temperature

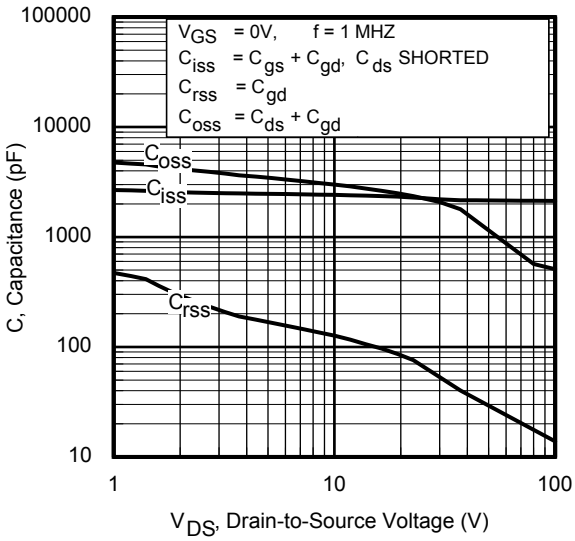

Fig 5. Typical Capacitance vs. Drain-to-Source Voltage

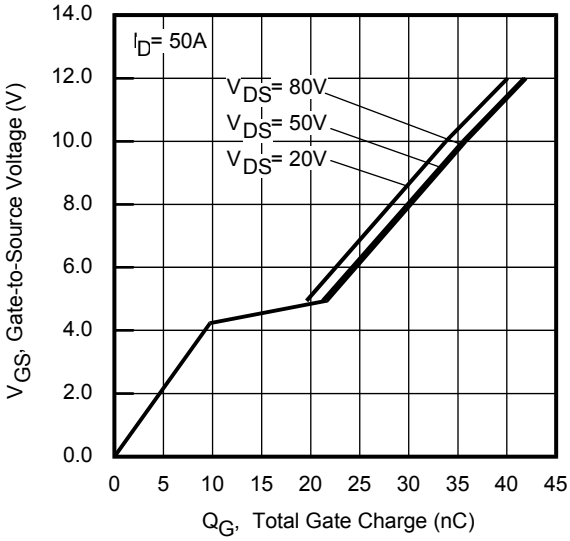

Fig 6. Typical Gate Charge vs. Gate-to-Source Voltage

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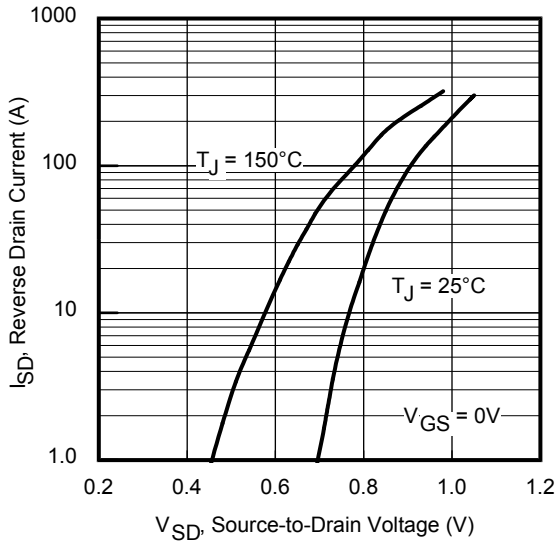

Fig 7. Typical Source-Drain Diode Forward Voltage

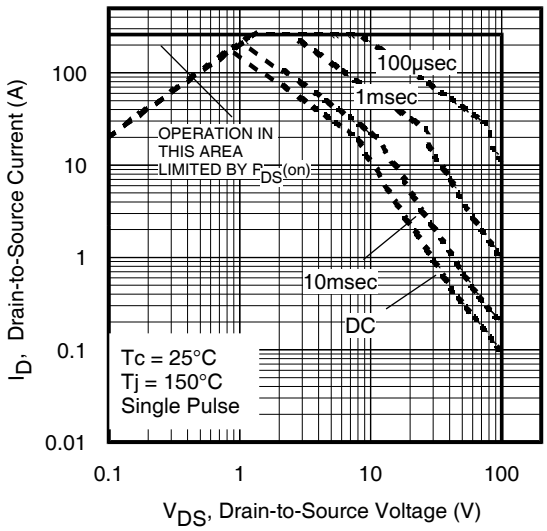

Fig 8. Maximum Safe Operating Area

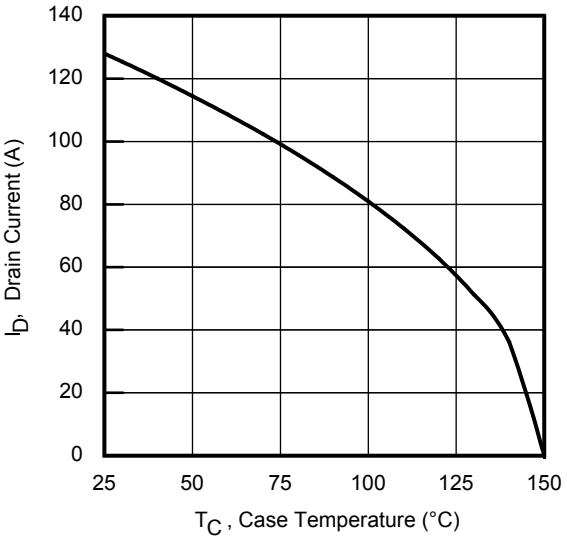

Fig 9. Maximum Drain Current vs. Case Temperature

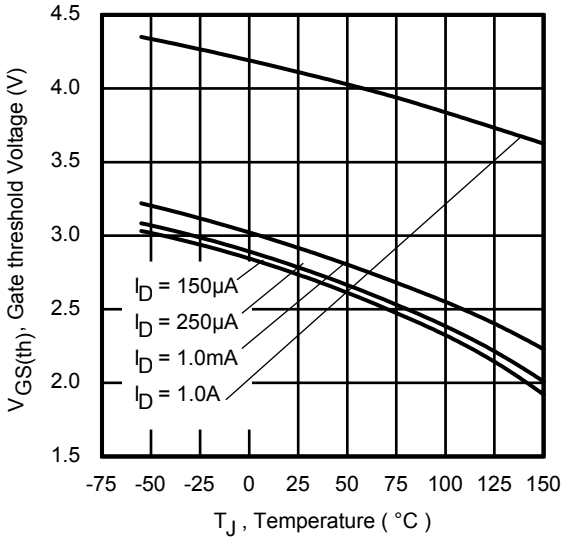

Fig 10. Threshold Voltage vs. Temperature

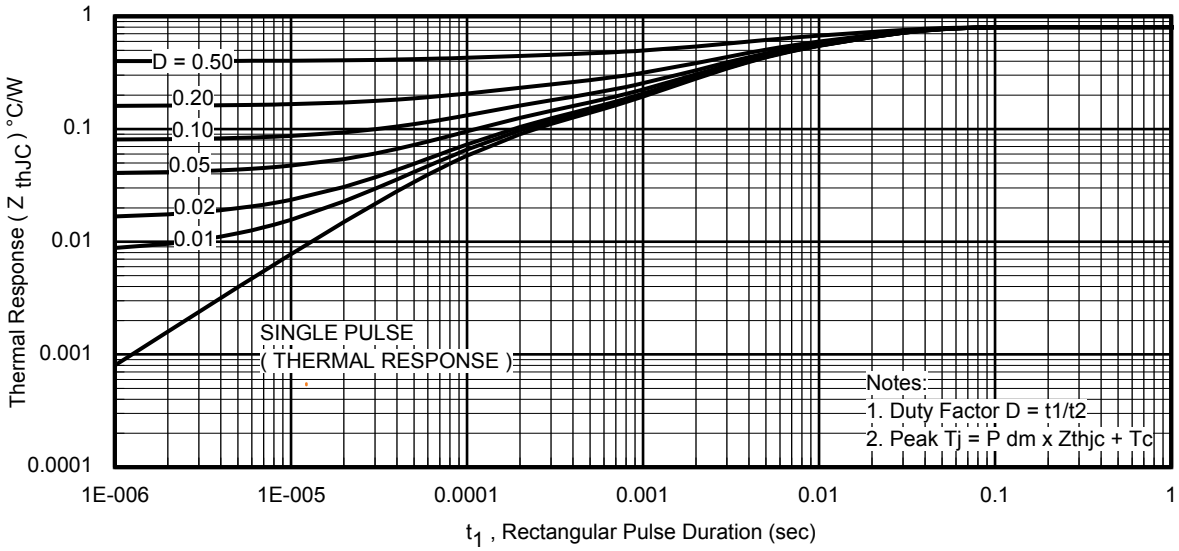

Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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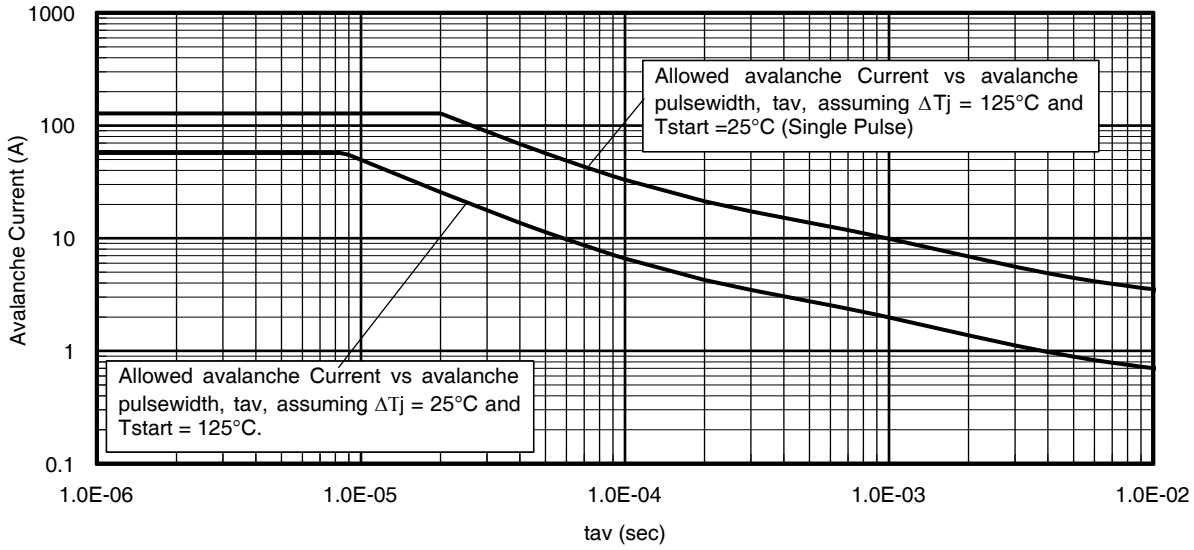

Fig 12. Typical Avalanche Current vs. Pulse Width

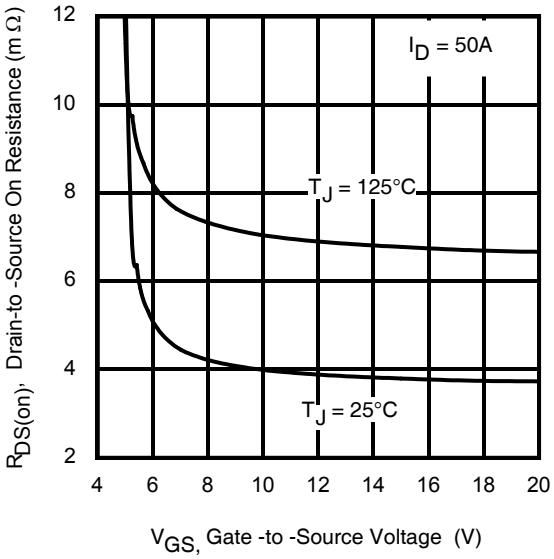

Fig 13. On–Resistance vs. Gate Voltage

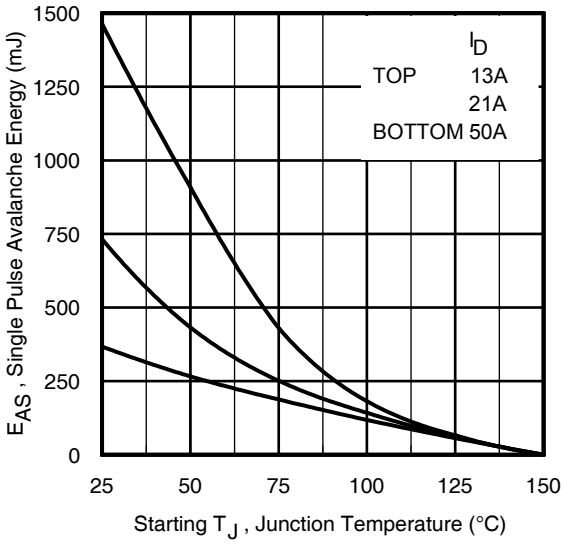

Fig 14. Maximum Avalanche Energy vs. Drain Current

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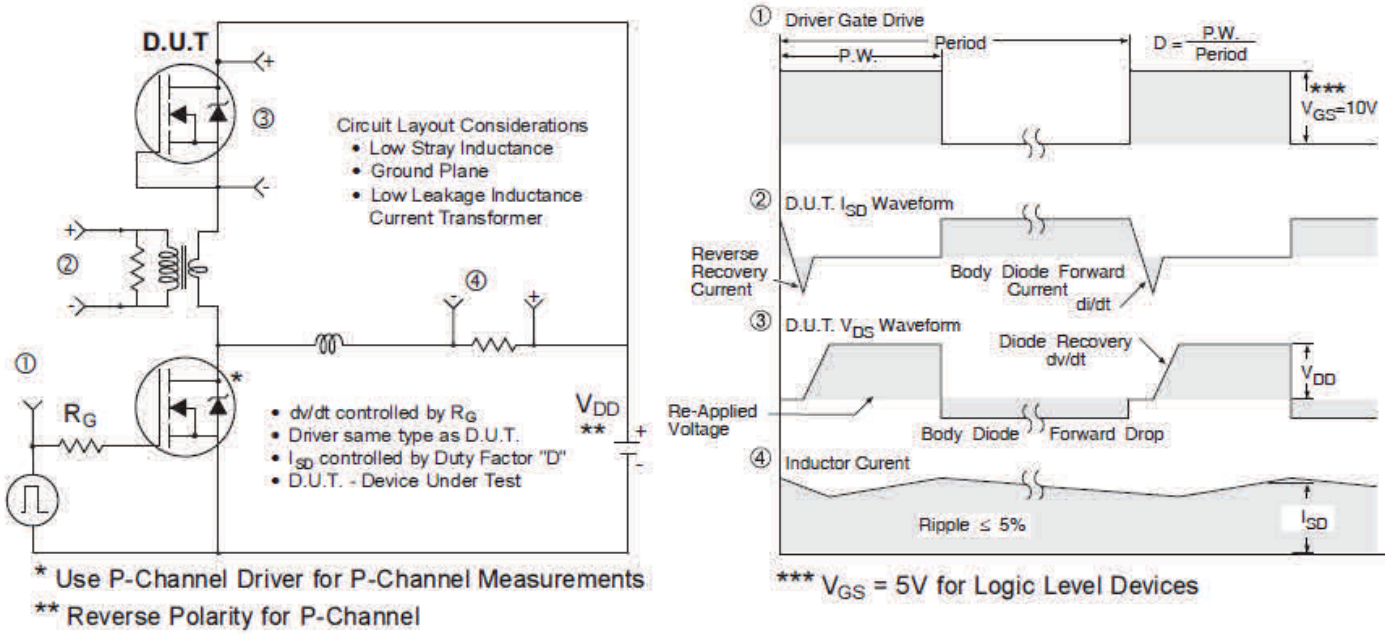

Fig 15. Peak Diode Recovery dv/dt Test Circuit for N-Channel HEXFET® Power MOSFETs

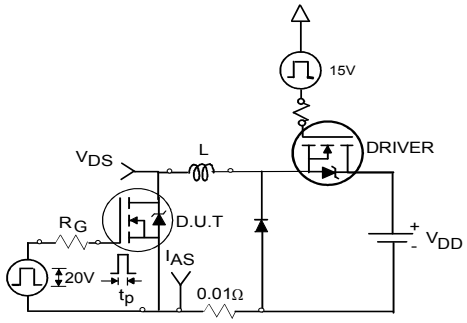

Fig 16a. Unclamped Inductive Test Circuit

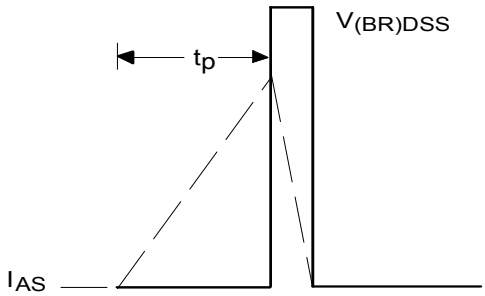

Fig 16b. Unclamped Inductive Waveforms

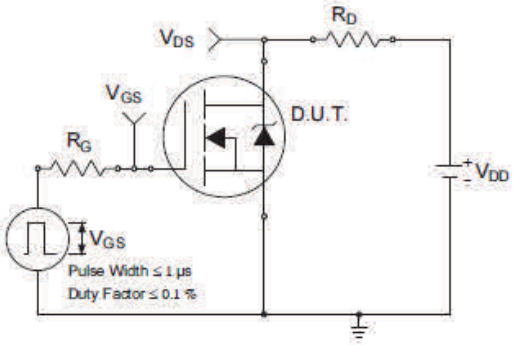

Fig 17a. Switching Time Test Circuit

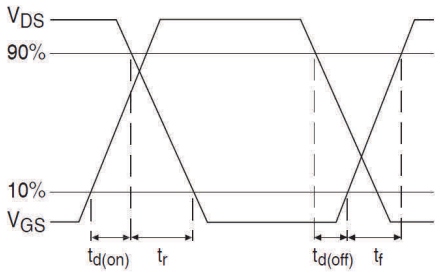

Fig 17b. Switching Time Waveforms

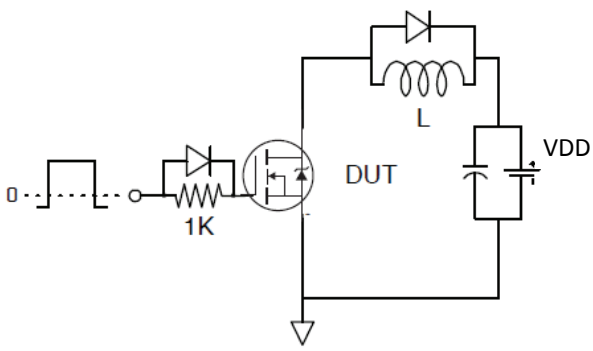

Fig 18. Gate Charge Test Circuit

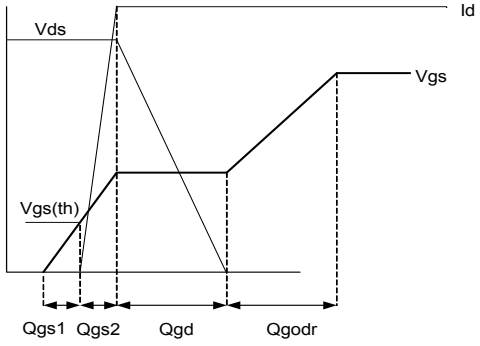

Fig 19. Gate Charge Waveform

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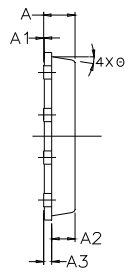
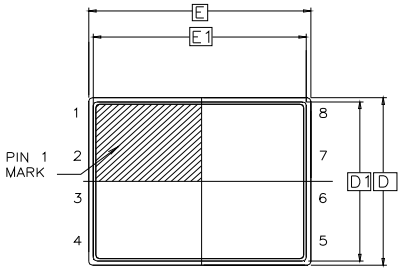
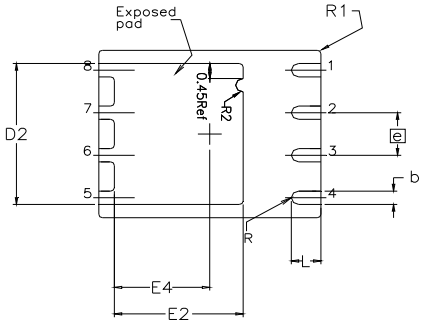
PQFN 5x6 Outline "B" Package Details



SIDE VIEW



TOP VIEW



BOTTOM VIEW

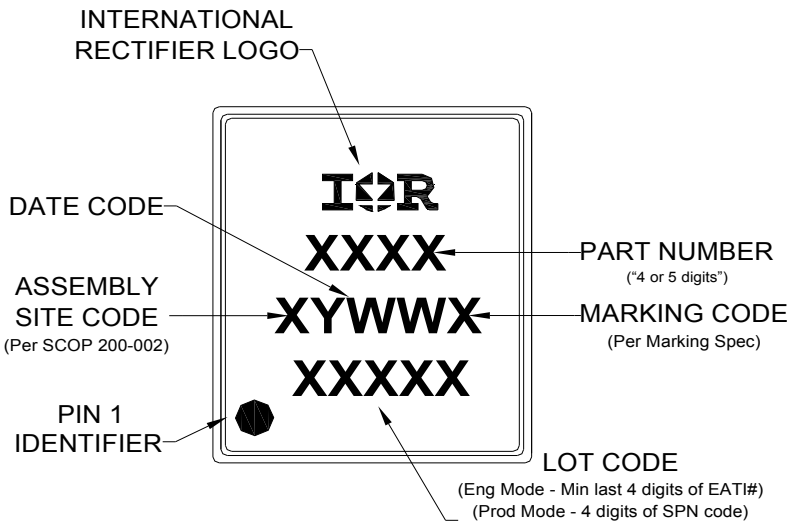
DIM / SYMBOL	MILLIMITERS MIN	MILLIMITERS MAX	INCH MIN	INCH MAX
A	0.800	1.050	0.0315	0.0413
A1	0.000	0.050	0.0000	0.0020
A2	0.580	0.680	0.0228	0.0268
A3	0.254 REF		0.0100 REF	
A4	0.127 REF		0.0050 REF	
D	4.850	5.150	0.1909	0.2028
D1	4.675	5.000	0.1841	0.1969
D2	3.700	4.300	0.1457	0.1693
E	5.850	6.150	0.2303	0.2421
E1	5.675	6.000	0.2234	0.2362
E2	3.380	3.780	0.1331	0.1488
E4	2.480	2.680	0.0976	0.2362
R	0.200 REF		0.0079 REF	
R1	0.100 REF		0.0039 REF	
R2	0.150	0.200	0.0059	0.0079
L	0.510	0.900	0.0201	0.0354
b	0.310	0.510	0.0122	0.0201
b1	0.025	0.125	0.0010	0.0049
b2	0.210	0.410	0.0083	0.0161
b3	0.150	0.450	0.0059	0.0177
e	1.270 REF		0.0500 REF	
e1	2.800 REF		0.1102 REF	
P	0°	12°	0°	12°
K	1.200	1.420	0.0472	0.0559

Note:

1. Dimensions and toleranceing confirm to ASME Y14.5M–1994
2. Dimension L represents terminal full back from package edge up to 0.1mm is acceptable
3. Coplanarity applies to the expose Heat Slug as well as the terminal
4. Radius on terminal is Optional

For more information on board mounting, including footprint and stencil recommendation, please refer to application note AN-1136: http://www.irf.com/technical-info/appnotes/an-1136.pdf
For more information on package inspection techniques, please refer to application note AN-1154: http://www.irf.com/technical-info/appnotes/an-1154.pdf

PQFN 5x6 Outline "B" Part Marking



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

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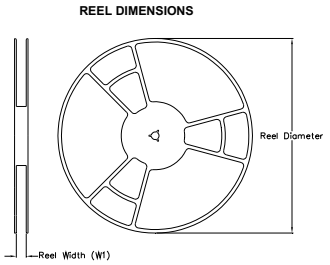
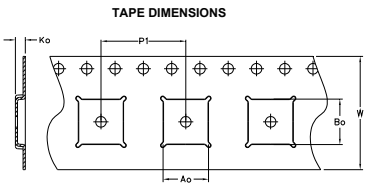
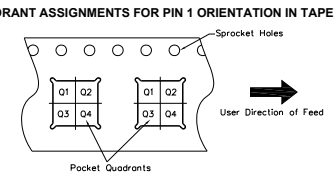
PQFN 5x6 Outline "B" Tape and Reel





CODE	DESCRIPTION
Ao	Dimension design to accommodate the component width
Bo	Dimension design to accommodate the component lenght
Ko	Dimension design to accommodate the component thickness
W	Overall width of the carrier tape
P_1	Pitch between successive cavity centers



Note: All dimension are nominal

Package Type	Reel Diameter (Inch)	QTY	Reel Width W1 (mm)	Ao (mm)	Bo (mm)	Ko (mm)	P1 (mm)	W (mm)	Pin 1 Quadrant
5 X 6 PQFN	13	4000	12.4	6.300	5.300	1.20	8.00	12	Q1

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/

Qualifiction Information†

Qualification Level	Industrial (per JEDEC JESD47F†† guidelines)	
Moisture Sensitivity Level	PQFN 5mm x 6mm	MSL1 (per JEDEC J-STD-020D††)
RoHS Compliant	Yes	

† Qualification standards can be found at International Rectifier's web site: http://www.irf.com/product-info/reliability/

†† Applicable version of JEDEC standard at the time of product release.

Notes:

① Repetitive rating; pulse width limited by max. junction temperature.
② Starting T_J = 25°C, L = 290µH, R_G = 50Ω, I_{AS} = 50A.
③ Pulse width ≤ 400µs; duty cycle ≤ 2%.
④ R_θ is measured at T_J of approximately 90°C.
⑤ When mounted on 1 inch square PCB (FR-4). Please refer to AN-994 for more details: http://www.irf.com/technical-info/appnotes/an-994.pdf

Revision History

Date	Comments
01/06/2015	• FIg 8 SOA Curve is corrected — The label PW = 1msec and 10msec are switched—page 4.

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